

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	306		2	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		3	
		35	L2		
C-RS-FR4-ML-0.610mm-035+035-TG150-HF-...	50203023	610		4	A01
		35	L3		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	216		5	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		6	
		35	L4		
C-RS-FR4-ML-0.610mm-035+035-TG150-HF-...	50203023	610		7	A02
		35	L5		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	216		8	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		9	
		35	L6		
C-RS-FR4-ML-0.610mm-035+035-TG150-HF-...	50203023	610		10	A03
		35	L7		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	306		11	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		12	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	13	

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

3120 µm

Version 1.2.20.35

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